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hed original documents or copy thereof

1. Name of Conveying Part(ies):  
Whonchee Lee

Additional name(s) of conveying  
party(ies) attached? ☐ Yes ☒ No

2. Name and address of receiving party(ies):

Name: Micron Technology, Inc.

Internal Address:

Street Address: 8000 South Federal Way

City: Boise State: ID Zip: 83706-9632

Additional names(s) & address(es) attached: ☐ Yes ☒ No

3. Nature of conveyance:

- ☒ Assignment ☐ Security Agreement  
☐ Merger ☐ Change of Name  
☐ Other

Execution Date: May 17, 1999

4. Application number(s) or patent number(s):

If this document is being filed together with a new application, the execution date of the application is: May 17, 1999

A. Patent Application No.(s):

69320381

Additional numbers attached: ☐ Yes ☒ No

B. Patent No.(s)

Additional numbers attached: ☐ Yes ☐ No

5. Name and address of party to whom  
correspondence concerning document should be  
mailed:

Name: David G. Latwesen, Ph.D.

Internal Address:  
Wells, St. John, Roberts,

Gregory & Matkin P.S.

Street Address: 601 W. First Avenue, Ste. 1300

City: Spokane State: WA Zip: 99201-3828

6. Total number of applications and  
patents involved. . . . . 1

7. Total fee (37 CFR 3.41). . . . . \$40.00

- ☒ Enclosed  
☐ Authorized to be charged to deposit account

8. Deposit account number  
23-0925

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To the best of my knowledge and belief, the foregoing information is true and correct and any attached copy is a true copy of the original document.

David G. Latwesen, Ph.D.

Name of Person Signing

David

Signature

5/17/99

Date

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PATENT ASSIGNMENT

PARTIES TO THE ASSIGNMENT:

INVENTOR:

Whonchee Lee

ASSIGNEE:

Micron Technology, Inc.  
Corporation of the State of Delaware  
8000 South Federal Way  
Boise, Idaho 83706-9632

BACKGROUND OF THIS ASSIGNMENT:

INVENTOR has conceived certain new and useful inventions disclosed in a United States patent application titled Semiconductor Processing Methods, And Methods Of Forming Capacitor Constructions.

MICRON TECHNOLOGY, INC. (hereinafter referred to as "ASSIGNEE") desires to acquire the entire right, title and interest in said inventions and with respect to any Letters Patent that may be granted with respect to the inventions in both the United States and in all foreign countries.

THE PARTIES AGREE AS FOLLOWS:

In consideration of good and valuable consideration, the receipt sufficiency and adequacy of which is hereby acknowledged, INVENTOR hereby sells, assigns and transfers to ASSIGNEE the entire right and interest in the above-identified application executed concurrently with this assignment and to any reissues, renewals, divisions or continuations thereof, and hereby

1 authorizes the Commissioner of Patents and Trademarks to issue such Letters  
2 Patent to ASSIGNEE for the sole use of ASSIGNEE, its successors or  
3 assigns.

4 INVENTOR further agrees to execute, at the request and expense of  
5 ASSIGNEE such other formal documents as may be required to fully convey  
6 the interest transferred herein and will similarly execute any application papers  
7 required for the filing of any division, continuation, renewal or reissue of the  
8 patent application or resulting Letters Patent; and will generally do everything  
9 necessary or desirable to obtain and enforce proper protection for the  
10 invention assigned hereby.

11 INVENTOR further assigns to ASSIGNEE the whole right, title and  
12 interest in the inventions disclosed in the application throughout all countries  
13 foreign to the United States. ASSIGNEE is hereby authorized to apply for  
14 patents relating to the inventions in its own name in countries where such  
15 procedure is proper; to claim the benefit of the International Convention; to  
16 file and prosecute International Applications relating to the inventions under  
17 the Patent Cooperation Treaty; and to file and prosecute applications relating  
18 to the inventions under the European Patent Convention. INVENTOR agrees  
19 to execute applications relating to the inventions in those countries and under  
20 those conventions where it is necessary that the same be executed by the  
21 inventor, and to execute assignments of such applications and the resulting  
22 Letters Patent to ASSIGNEE as well as all other necessary papers in relation  
23 to such applications and Letters Patent.

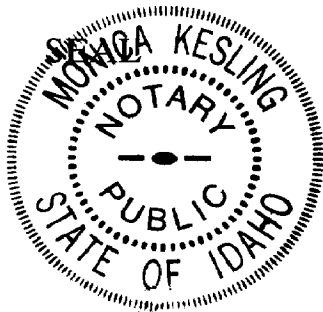
INVENTOR further warrants and covenants that no assignment, grant, mortgage, license or other agreement affecting the rights and property herein conveyed has been or will be made to others by the undersigned, and that the full rights to convey the same as herein expressed is possessed by the undersigned.

To be binding on the heirs, assigns, representatives and successors of the undersigned and extend to the successors, assigns and nominees of the Assignees.

(Signature) Whonchee Lee Date: 5/17/99  
Whonchee Lee

State of Idaho )  
County of Blaine ) ss.

BEFORE ME, this 17<sup>th</sup> day of May 1999 personally appeared the above-named inventor, to me known to be the person who is described in and who executed the foregoing assignment instrument and acknowledged to me that he/she executed the same of his/her own free will for the purpose therein expressed.



Monica Kesling  
Notary or Consular Officer  
My Commission Expires: 5-17-2005